

Atty Docket No.: TKHR4580

Serial No.: 09/479,483

*Sub D67*

1. (Twice Amended) A fabrication method for a multi-layered thin film protective layer, which is applicable to a substrate comprising a first device area and a second device area, the method comprising the steps of:

forming a first protective layer on the first device area, wherein the first protective layer prevents the first device area from moisture and scratch;

forming a plurality of material structures on the first protective layer, the material structures and the underlying first protective layer together formed as first pad spacers;

forming a plurality of oxide material/silicon nitride/oxide material structures on the second device area as second pad spacers in the second device area, wherein the second pad spacers are higher than the first protective layer; and

forming a second protective layer for at least covering the second device area, wherein a transparency of the second protective layer is higher than a transparency of the first protective layer.

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18. (Once amended) A fabrication method for a multi-layered thin film protective layer, which is applicable to a substrate comprising a first device area and a second device area, the method comprising the steps of:

forming a first protective layer on the first device area, wherein the first protective layer prevents the first device area from moisture and scratch;

forming a plurality of material structures on the first protective layer, the material structures and the underlying first protective layer together formed as first pad spacers;

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~~forming a plurality of multi-layered material structures on the second device area as second pad spacers in the second device area, wherein the second pad spacers are higher than the first protective layer; and~~

~~forming a second protective layer at least covering the second device area, wherein a transparency of the second protective layer is higher than a transparency of the first protective layer.~~